

12500 TI Boulevard, MS 8640, Dallas, Texas 75243

PCN# 20230206001.0 Marking Standardization for Select Devices Information Only

Date: February 07, 2023

To: TOKYO ELECTRON DEVICE (DSTR) PCN

Dear Customer:

This is an information-only announcement of a change to a device that is currently offered by Texas Instruments.

The changes discussed within this notification are for your information only.

Any negotiated alternative change requirements will be provided via the customer's defined process. Customers with previously negotiated, special requirements will be handled separately. Any inquiries should be directed to your local Field Sales Representative.

For questions regarding this notice, contact your local Field Sales Representative or the PCN Team (<u>PCN www admin team@list.ti.com</u>).

Sincerely,

PCN Team SC Business Services

20230206001.0 Attachment: 1

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months (60 months for Automotive devices). The corresponding customer part number is also listed, if available.

DEVICE	CUSTOMER PART NUMBER
ADS8331IPW	null
ADS774JU/1K	null
ADS774JU	null
ADS7951SBDBT	null
ADS7952SRHBT	null
ADS7953SBDBT	null
ADS7961SRHBR	null
ADS7841E	null
ADS7950SBRGER	null
ADS7951SBRGER	null
ADS7952SBDBTR	null
ADS7953SDBTR	null
ADS7957SRHBR	null
ADS8331IRGER	null
ADS8332IRGER	null
ADS774KU	null
ADS7961SDBT	null
ADS7959SRGET	null
ADS8332IBRGET	null
ADS7958SDBT	null
ADS7957SDBT	null
ADS7951SBDBTR	null
ADS7953SBDBTR	null
ADS7952SBRHBR	null
ADS7952SBRHBT	null
ADS7841E/2K5	null
ADS7956SDBT	null
ADS7952SBDBT	null
ADS7952SRHBR	null
ADS7951SRGER	null
ADS7958SRGER	null

Technical details of this Product Change follow on the next page(s).

PCN	Number:	202302060	01.0		PCNI	Date:	February 07, 2023	
Title	: Marking Stan	dardization f	or Se	elect Devices				
Customer Contact: PCN Manager Dept: Quality Services								
Cha	nge Type:							
	Assembly Site			Design		Wafer	Bump Site	
	Assembly Process			Data Sheet		Wafer Bump Material		
☐ Assembly Materials			Part number change					
☐ Mechanical Specification		Щ	Test Site	\dashv	Wafer Fab Site			
\boxtimes	Packing/Shipping/	Labeling	Ш	Test Process	ᆛ片	Wafer Fab Materials		
				DCN Dataila		Wafer	Vafer Fab Process	
PCN Details								
Description of Change:								
This notice is to communicate an update in the device symbolization format for the devices in the product affected selection as follows:								
				Current	New		•	
	Post symbol		Ir	nclude value		Remov	/e	
			B	ADS7951 \T/ YMSG4 LLLL	0	\T/ \	7951 YMSG4 LLL	
YM S LLLI E		'M = YI S = AS LL = LO B = PO	TI LOGO EAR MONTH DATE CODE SSY SITE CODE DT TRACE CODE DST SYMBOL MARKING IN 1 INDICATOR	\TI/ = TI LOGO YM = YEAR MONTH DATE CODE S = ASSY SITE CODE LLLL = LOT TRACE CODE O = PIN 1 INDICATOR				
Reason for Change:								
Marking Standardization								
Anti	cipated impact or	Fit, Form,	Fund	ction, Quality or Relia	bility (positiv	e / negative):	
None	9							
Changes to product identification resulting from this PCN:								
Device symbolization								
Proc	luct Affected:							
ADS7952SBDBT ADS8331IB			BRGE	BRGER ADS8332IBPV		R ADS774KU/1K		
ADS7952SBDBTR ADS8331IE				GER				
		ADS8331II	BPW			·		
<u> </u>		ADS7953S				ADS7841EB/2K5		
		ADS7953S				ADS7841EB		
ADS7951SBDBTR ADS7952S								
ADS8331IBRGET ADS7952S					ADS774JU			

For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

Location	E-Mail
-	

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